

## Master Bond EP21TDC-2 Highly Flexible Cryogenic Epoxy Compound

Category: Polymer, Adhesive, Thermoset, Epoxy, Epoxy Adhesive

## **Material Notes:**

Master Bond Polymer System EP21TDC-2 is a two component highly flexible epoxy resin compound for high performance bonding, sealing, coating and encapsulation. It is formulated to cure fully at ambient temperature or more quickly at elevated temperatures with a non-critical one to three mix ratio by weight. The cured compound has very high peel strength, greater than 30 pli, and an elongation of over 150%. Serviceable at cryogenic temperatures.

## Order this product through the following link:

http://www.lookpolymers.com/polymer\_Master-Bond-EP21TDC-2-Highly-Flexible-Cryogenic-Epoxy-Compound.php

Physical Properties	Metric	English	Comments
Viscosity	70000 - 80000 cP	70000 - 80000 cP	
	@Temperature 23.0 °C	@Temperature 73.4 °F	

Thermal Properties	Metric	English	Comments
Maximum Service Temperature, Air	121 °C	250 °F	
Minimum Service Temperature, Air	-269 °C	-453 °F	

Processing Properties	Metric	English	Comments
Cure Time	120 - 180 min	2.00 - 3.00 hour	
	@Temperature 93.3 °C	@Temperature 200 °F	
	4320 min	72.0 hour	
	@Temperature 23.0 °C	@Temperature 73.4 °F	

Descriptive Properties	Value	Comments
Color Code	"A" Clear; "B" Amber	
Mix Ratio By Weight	33/100	
Set-Up Time, minutes	75-90	At Room Temperature

## Contact Songhan Plastic Technology Co.,Ltd.

Website: www.lookpolymers.com Email: sales@lookpolymers.com

Tel: +86 021-51131842 Mobile: +86 13061808058 Skype: lookpolymers



Address: United North Road 215, Fengxian District, Shanghai City, China